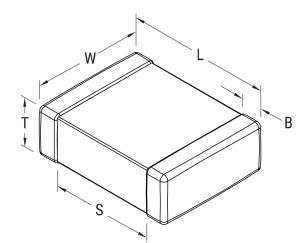


C0603S223J3RACTU

Aliases (C0603S223J3RAC7867)

SMD Comm X7R FE, Ceramic, 0.022 uF, 5%, 25 VDC, X7R, SMD, MLCC, FE-CAP, Floating Electrode, Temperature Stable, 0603



Click here for the 3D model.

Chip Size 0603 L 1.6mm +/-0.15mm W 0.8mm +/-0.15mm
W 0.8mm +/-0.15mm
T 0.8mm +/-0.07mm
S 0.7mm MIN
B 0.35mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information	١
Series	SMD Comm X7R FE
Style	SMD Chip
Description	SMD, MLCC, FE-CAP, Floating Electrode, Temperature Stable
Features	FE-CAP, Floating Electrode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	4.8 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.022 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	3.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	45.4545 GOhms

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